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July 2010



SEMICONDUCTOR®

FDP8896_F085

N-Channel PowerTrench[®] MOSFET 30V, 92A, 5.9m Ω

General Description

This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $r_{\text{DS}(\text{ON})}$ and fast switching speed.

Applications

· DC/DC converters



Features

- $r_{DS(ON)} = 5.9 \text{m}\Omega$, $V_{GS} = 10 \text{V}$, $I_D = 35 \text{A}$
- $r_{DS(ON)} = 7.0 \text{m}\Omega$, $V_{GS} = 4.5 \text{V}$, $I_D = 35 \text{A}$
- High performance trench technology for extremely low rDS(ON)
- · Low gate charge
- · High power and current handling capability
- Qualified to AEC Q101
- RoHS Compliant







MOSFET Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter	Ratings	Units	
V _{DSS}	Drain to Source Voltage	30	V	
V _{GS}	Gate to Source Voltage	±20	V	
	Drain Current			
I _D	Continuous (T _C = 25°C, V _{GS} = 10V) (Note 1)	92	Α	
	Continuous (T _C = 25°C, V _{GS} = 4.5V) (Note 1)	85	Α	
	Continuous ($T_{amb} = 25^{\circ}C$, $V_{GS} = 10V$, with $R_{\theta JA} = 62^{\circ}C/W$)	16	Α	
	Pulsed	Figure 4	Α	
E _{AS}	Single Pulse Avalanche Energy (Note 2)	74	mJ	
	Power dissipation	80	W	
P_{D}	Derate above 25°C	0.53	W/°C	
T _J , T _{STG}	Operating and Storage Temperature	-55 to 175	°C	

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance Junction to Case TO-220	1.88	°C/W
R _{e,IA}	Thermal Resistance Junction to Ambient TO-220 (Note 3)	62	°C/W

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity	
FDP8896	FDP8896_F085	TO-220AB	Tube	N/A	50 units	

Symbol	Parameter	Test Conditions		Min	Тур	Max	Units
Off Chara	cteristics						
B _{VDSS}	Drain to Source Breakdown Voltage	I _D = 250μA, V _{GS}	= 0V	30	-	-	V
	7 0 1 1/1 1 1 1 1 1	V _{DS} = 24V		-	-	1	
I _{DSS}	Zero Gate Voltage Drain Current	V _{GS} = 0V	T _C = 150°C	-	-	250	μΑ
I _{GSS}	Gate to Source Leakage Current	V _{GS} = ±20V	<u> </u>	•	-	±100	nA
On Chara	cteristics						
V _{GS(TH)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D =$	250μΑ	1.2	-	2.5	V
33(111)		I _D = 35A, V _{GS} = 10V		-	0.0050	0.0059	
	Desira to Course On Desiratores	$I_D = 35A, V_{GS} = 4.5V$		-	0.0060	0.0070	0
r _{DS(ON)}	Drain to Source On Resistance	$I_D = 35A$, $V_{GS} = 10V$, $T_J = 175$ °C		-	0.0078	0.0094	Ω
Dynamic	Characteristics						
C _{ISS}	Input Capacitance	V _{DS} = 15V, V _{GS} = 0V, f = 1MHz		-	2525	-	pF
C _{OSS}	Output Capacitance			-	490	-	pF
C _{RSS}	Reverse Transfer Capacitance			-	300	-	pF
R _G	Gate Resistance	$V_{GS} = 0.5V, f = 1$	MHz	-	2.3	-	Ω
Q _{q(TOT)}	Total Gate Charge at 10V	V _{GS} = 0V to 10V		-	48	67	nC
Q _{g(5)}	Total Gate Charge at 5V	$V_{GS} = 0V \text{ to } 5V$		-	25	36	nC
Q _{g(TH)}	Threshold Gate Charge	V _{GS} = 0V to 1V	V _{DD} = 15V	-	2.3	3.0	nC
Q _{gs}	Gate to Source Gate Charge		[∐] I _D = 35A I _q = 1.0mA	-	8	-	nC
Q _{gs2}	Gate Charge Threshold to Plateau		ig = 1.0mA	-	5.7	-	nC
Q _{gd}	Gate to Drain "Miller" Charge			•	9.5	-	nC
Switching	Characteristics (V _{GS} = 10V)						
t _{ON}	Turn-On Time			-	-	168	ns
t _{d(ON)}	Turn-On Delay Time			-	9	-	ns
t _r	Rise Time	V _{DD} = 15V, I _D = 3	35A	-	103	-	ns
t _{d(OFF)}	Turn-Off Delay Time	$V_{GS} = 4.5V, R_{GS} = 6.2\Omega$		-	56	-	ns
t _f	Fall Time			-	44	-	ns
t _{OFF}	Turn-Off Time			-	-	150	ns
Drain-Sou	urce Diode Characteristics						
V _{SD}	0	I _{SD} = 35A		-	-	1.25	V
	Source to Drain Diode Voltage	I _{SD} = 20A		-	-	1.0	V
t _{rr}	Reverse Recovery Time	$I_{SD} = 35A$, dI_{SD}/c	dt = 100A/μs	-	-	27	ns
Q _{RR}	Reverse Recovered Charge	$I_{SD} = 35A$, dI_{SD}/c		-	-	12	nC

Downloaded from Arrow.com.

Notes: 1: Package current limitation is 80A. 2: Starting T_J = 25°C, L = 36 μ H, I_{AS} = 64A, V_{DD} = 27V, V_{GS} = 10V. 3: Pulse width = 100s.

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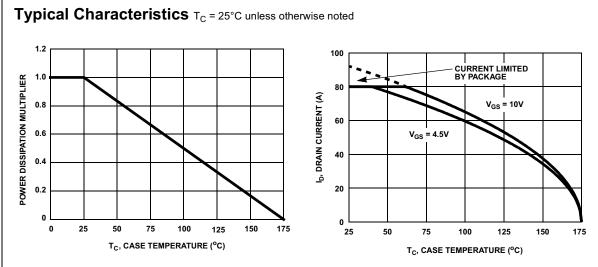


Figure 1. Normalized Power Dissipation vs Case Temperature

Figure 2. Maximum Continuous Drain Current vs Case Temperature

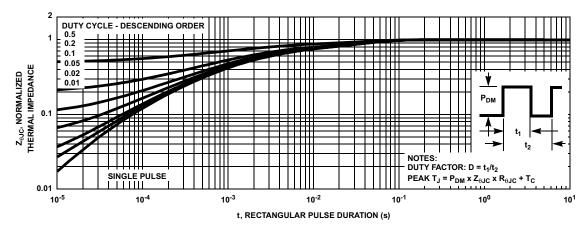


Figure 3. Normalized Maximum Transient Thermal Impedance

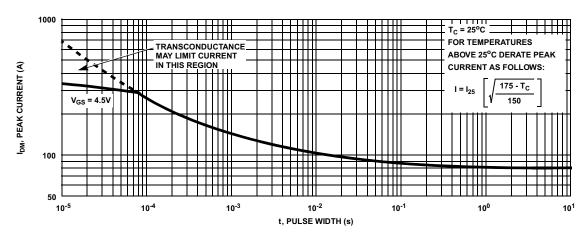
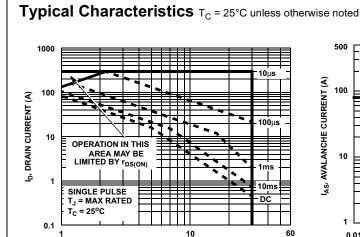


Figure 4. Peak Current Capability



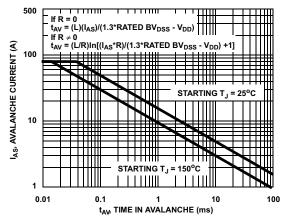


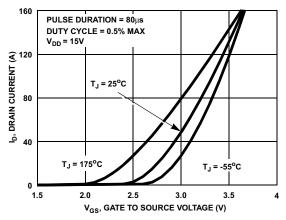
Figure 5. Forward Bias Safe Operating Area

V_{DS}, DRAIN TO SOURCE VOLTAGE (V)

NOTE: Refer to Fairchild Application Notes AN7514 and AN7515

Figure 6. Unclamped Inductive Switching

Capability



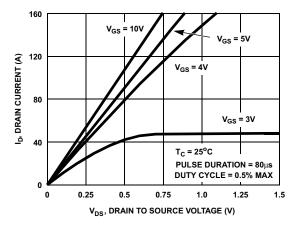
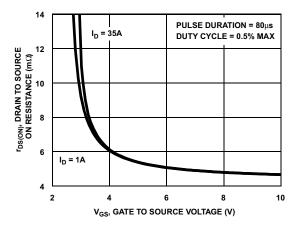


Figure 7. Transfer Characteristics

Figure 8. Saturation Characteristics



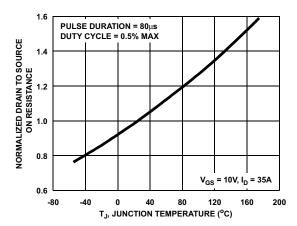


Figure 9. Drain to Source On Resistance vs Gate Voltage and Drain Current

Figure 10. Normalized Drain to Source On Resistance vs Junction Temperature

Typical Characteristics $T_C = 25^{\circ}C$ unless otherwise noted

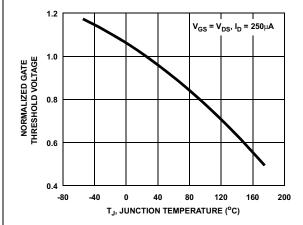


Figure 11. Normalized Gate Threshold Voltage vs Junction Temperature

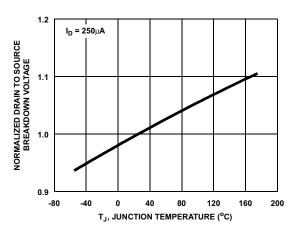


Figure 12. Normalized Drain to Source Breakdown Voltage vs Junction Temperature

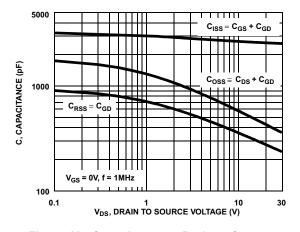


Figure 13. Capacitance vs Drain to Source Voltage

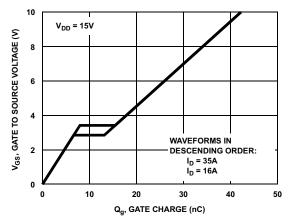


Figure 14. Gate Charge Waveforms for Constant Gate Current

Test Circuits and Waveforms

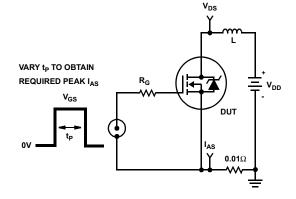


Figure 15. Unclamped Energy Test Circuit

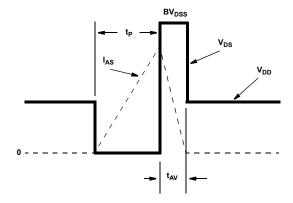


Figure 16. Unclamped Energy Waveforms

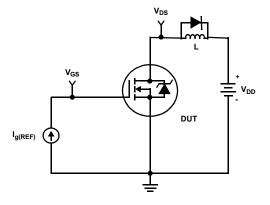


Figure 17. Gate Charge Test Circuit

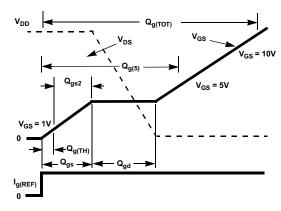


Figure 18. Gate Charge Waveforms

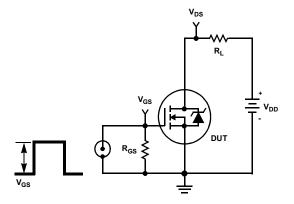


Figure 19. Switching Time Test Circuit

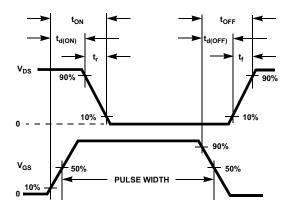
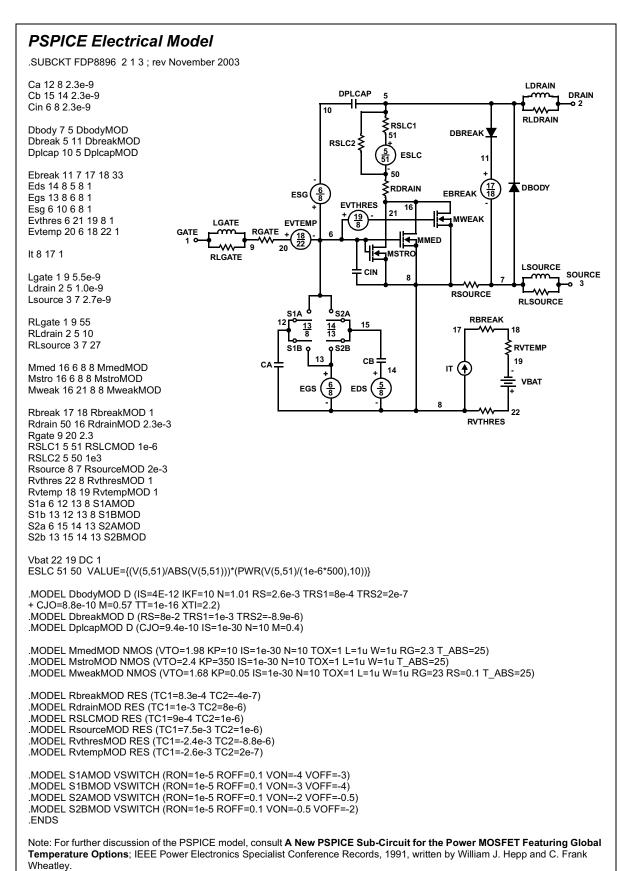


Figure 20. Switching Time Waveforms



```
SABER Electrical Model
rev November 2003
template FDP8896 n2,n1,n3 =m temp
electrical n2,n1,n3
number m_temp=25
var i iscl
dp..model dbodymod = (isl=4e-12,ikf=10,nl=1.01,rs=2.6e-3,trs1=8e-4,trs2=2e-7,cjo=8.8e-10,m=0.57,tt=1e-16,xti=2.2)
dp..model dbreakmod = (rs=8e-2,trs1=1e-3,trs2=-8.9e-6)
dp..model dplcapmod = (cjo=9.4e-10,isl=10e-30,nl=10,m=0.4)
m..model mmedmod = (type=_n, vto=1.98, kp=10, is=1e-30, tox=1)
m..model mstrongmod = (type=_n,vto=2.4,kp=350,is=1e-30, tox=1)
m..model mweakmod = (type=_n,vto=1.68,kp=0.05,is=1e-30, tox=1,rs=0.1)
                                                                                                               LDRAIN
sw_vcsp..model s1amod = (ron=1e-5,roff=0.1,von=-4,voff=-3)
                                                                      DPLCAP
                                                                                                                        DRAIN
sw_vcsp..model s1bmod = (ron=1e-5,roff=0.1,von=-3,voff=-4)
                                                                   10
sw vcsp..model s2amod = (ron=1e-5,roff=0.1,von=-2,voff=-0.5)
                                                                                                              RLDRAIN
sw vcsp..model s2bmod = (ron=1e-5,roff=0.1,von=-0.5,voff=-2)
                                                                                  RSLC1
c.ca n12 n8 = 2.3e-9
                                                                                 51
                                                                    RSLC2 €
c.cb n15 n14 = 2.3e-9
                                                                                   ISCI
c.cin n6 n8 = 2.3e-9
                                                                                              DBRFAK T
                                                                                  50
dp.dbody n7 n5 = model=dbodymod
                                                                                  RDRAIN
                                                                 8
dp.dbreak n5 n11 = model=dbreakmod
                                                            FSG
                                                                                                              DBODY
dp.dplcap n10 n5 = model=dplcapmod
                                                                      EVTHRES
                                                                         (<u>19</u>)
                                                                                              MWEAK
                                          LGATE
                                                          EVTEMP
spe.ebreak n11 n7 n17 n18 = 33
                                                   RGATE
                                   GATE
                                                             18
22
                                                                                                EBREAK
spe.eds n14 n8 n5 n8 = 1
                                                                                   MMED
                                                                            MSTRO
spe.egs n13 n8 n6 n8 = 1
                                          RLGATE
spe.esg n6 n10 n6 n8 = 1
                                                                                                              LSOURCE
spe.evthres n6 n21 n19 n8 = 1
                                                                            CIN
                                                                                                                        SOURCE
spe.evtemp n20 n6 n18 n22 = 1
                                                                                            RSOURCE
                                                                                                              RLSOURCE
i.it n8 n17 = 1
                                                                                                   RBREAK
I.lgate n1 n9 = 5.5e-9
                                                                                               17
I.Idrain n2 n5 = 1.0e-9
                                                                                                           ₹RVTEMP
                                                                    o S2B
I.Isource n3 n7 = 2.7e-9
                                                                                                            19
                                                     СА
                                                                                              IT
                                                                                                (≱
                                                                                 14
res.rlgate n1 n9 = 55
                                                                                                              VBAT
res.rldrain n2 n5 = 10
                                                             EGS
                                                                         EDS
res.rlsource n3 n7 = 27
m.mmed n16 n6 n8 n8 = model=mmedmod, I=1u, w=1u, temp=m_temp
                                                                                                  RVTHRES
m.mstrong n16 n6 n8 n8 = model=mstrongmod, l=1u, w=1u, temp=m_temp
m.mweak n16 n21 n8 n8 = model=mweakmod, l=1u, w=1u, temp=m_temp
res.rbreak n17 n18 = 1, tc1=8.3e-4,tc2=-4e-7
res.rdrain n50 n16 = 2.3e-3, tc1=1e-3,tc2=8e-6
res.rgate n9 n20 = 2.3
res.rslc1 n5 n51 = 1e-6, tc1=9e-4,tc2=1e-6
res.rslc2 n5 n50 = 1e3
res.rsource n8 n7 = 2e-3, tc1=7.5e-3,tc2=1e-6
res.rvthres n22 n8 = 1, tc1=-2.4e-3,tc2=-8.8e-6
res.rvtemp n18 n19 = 1. tc1=-2.6e-3.tc2=2e-7
sw_vcsp.s1a n6 n12 n13 n8 = model=s1amod
sw_vcsp.s1b n13 n12 n13 n8 = model=s1bmod
sw_vcsp.s2a n6 n15 n14 n13 = model=s2amod
sw vcsp.s2b n13 n15 n14 n13 = model=s2bmod
v.vbat n22 n19 = dc=1
equations {
iscl: v(n51,n50) = ((v(n5,n51)/(1e-9+abs(v(n5,n51))))*((abs(v(n5,n51)*1e6/500))** 10))
```

PSPICE Thermal Model JUNCTION REV 23 November 2003 FDP8896T CTHERM1 TH 6 9e-4 CTHERM2 6 5 1e-3 CTHERM3 5 4 2e-3 RTHERM1 CTHERM1 CTHERM4 4 3 3e-3 CTHERM5 3 2 7e-3 CTHERM6 2 TL 8e-2 RTHERM1 TH 6 3.0e-2 RTHERM2 6 5 1.0e-1 RTHERM3 5 4 1.8e-1 RTHERM2 CTHERM2 RTHERM4 4 3 2.8e-1 RTHERM5 3 2 4.5e-1 RTHERM6 2 TL 4.6e-1 5 SABER Thermal Model SABER thermal model FDP8896T RTHERM3 CTHERM3 template thermal_model th tl thermal c th, tl ctherm.ctherm1 th 6 =9e-4 ctherm.ctherm2 6 5 =1e-3 ctherm.ctherm3 5 4 =2e-3 ctherm.ctherm4 4 3 =3e-3 ctherm.ctherm5 3 2 =7e-3 RTHERM4 CTHERM4 ctherm.ctherm6 2 tl =8e-2 rtherm.rtherm1 th 6 = 3.0e-2 rtherm.rtherm2 6 5 =1.0e-1 3 rtherm.rtherm3 5 4 =1.8e-1 rtherm.rtherm4 4 3 =2.8e-1 rtherm.rtherm5 3 2 =4.5e-1 CTHERM5 RTHERM5 rtherm.rtherm6 2 tl =4.6e-1 2 RTHERM6 CTHERM6 CASE tl





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